

<p style="text-align: center;">O I P E</p> <p>U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE</p> <p>AUG 6 2003 (use several sheets if necessary)</p> <p>PATENT & TRADEMARK OFFICE</p>				ATTY DOCKET NO. 03500.017376.	APPLICATION NO. 10/615,305		
				APPLICANT MASAHIKO KUBOTA ET AL.			
				FILING DATE July 9, 2003		GROUP NYA	
U.S. PATENT DOCUMENTS							
EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE	
<i>mkl</i>	4,657,631	04/14/87	Noguchi	156	655		
<i>mkl</i>	5,331,344	07/19/94	Miyagawa et al.	347	63		
<i>mkl</i>	5,478,606	12/26/95	Ohkuma et al.	427	555		
<i>mkl</i>	6,158,843	12/12/00	Murthy et al.	347	47		
<i>mkl</i>	4,565,859	01/21/86	Mural et al.	528	365		
<i>mkl</i>	6,158,843	12/12/00	Murthy et al.	347	47		
<i>mkl</i>	4,882,595	12/21/89	Trueba et al.	346	140 R		
<i>mkl</i>	6,179,413 B1	01/30/01	Coulman et al.	347	63		
FOREIGN PATENT DOCUMENTS							
	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES/NO/ OR ABSTRACT	
<i>mkl</i>	JP 64-9216	1/12/1989	Japan	—	—	Abstract	
<i>mkl</i>	JP 2000/326515	11/28/2000	Japan	—	—	Abstract	
<i>mkl</i>	JP 6-45242	6/15/1994	Japan	—	—	Abstract & U.S. Patent No. 4,657,631	
<i>mkl</i>	JP 2-140219	5/29/1990	Japan	—	—	Abstract	
<i>mkl</i>	JP 4-216952	8/7/1992	Japan	—	—	Abstract & U.S. Patent No. 5,331,344	
<i>mkl</i>	JP 3143307	12/22/2000	Japan	—	—	Abstract & U.S. Patent No. 5,478,606	
<i>mkl</i>	JP 10-291317	11/4/1998	Japan	—	—	Abstract & U.S. Patent No. 6,158,843	
<i>mkl</i>	JP 63-221121	9/14/1988	Japan	—	—	Abstract	
<i>mkl</i>	JP 60-161973	8/23/1985	Japan	—	—	Abstract & U.S. Patent 4,565,859	
OTHER DOCUMENT(S) (including Author, Title, Date, Pertinent Pages, Etc.)							
<i>mkl</i>		Journal of Polymer Science "Fourth International Symposium on Cationic Polymerization", pp 383-395, (1976).					
EXAMINER		<i>mkl</i>		DATE CONSIDERED		9/29/04	

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.